

DATA SHEET

# SKY13373-460LF: 0.1 to 6.0 GHz SP3T Switch

## Applications

- WCDMA band and mode switching
- Antenna switch for multimode systems
- 802.11a/b/g/n WLANs

## Features

- Broadband frequency range: 0.1 to 6.0 GHz
- Low insertion loss: 0.45 dB @ 2.5 GHz
- High isolation: 30 dB up to 2.5 GHz
- No external DC blocking capacitors required
- Positive low voltage control:  $V_{CTL} = 1.65$  to  $3.00$  V,  $V_{DD} = 2.5$  to  $4.8$  V
- Small, QFN (12-pin, 2 x 2 mm) package (MSL1, 260 °C per JEDEC J-STD-020)



Skyworks Green™ products are compliant with all applicable legislation and are halogen-free. For additional information, refer to *Skyworks Definition of Green™*, document number SQ04-0074.

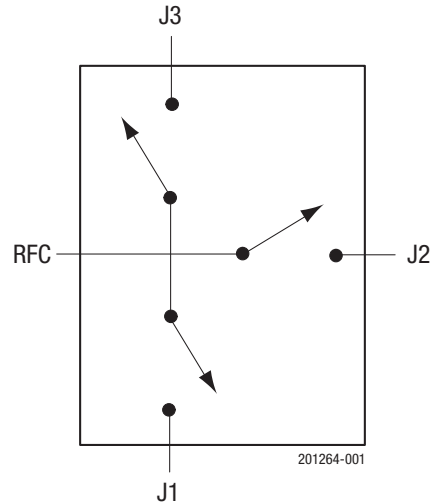


Figure 1. SKY13373-460LF Block Diagram

## Description

The SKY13373-460LF is a CMOS silicon-on-insulator (SOI), single-pole, triple-throw (SP3T) switch. The high linearity performance and low insertion loss makes the device an ideal choice for WCDMA handset and data card applications.

The SKY13373-460LF SP3T switch is provided in a compact Quad Flat No-Lead (QFN) 2 x 2 mm package. A functional block diagram is shown in Figure 1. The pin configuration and package are shown in Figure 2. Signal pin assignments and functional pin descriptions are provided in Table 1.

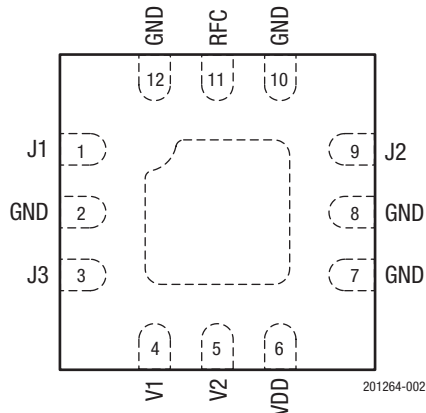


Figure 2. SKY13373-460LF Pinout (Top View)

**Table 1. SKY13373-460LF Signal Descriptions<sup>1</sup>**

Pin	Name	Description	Pin	Name	Description
1	J1	RF port 1	7	GND	Ground
2	GND	Ground	8	GND	Ground
3	J3	RF port 3.	9	J2	RF port 2
4	V1	DC control voltage 1 (See Table 4)	10	GND	Ground
5	V2	DC control voltage 2 (See Table 4)	11	RFC	RF common (antenna) port
6	VDD	DC power supply	12	GND	Ground

<sup>1</sup> Exposed pad must be grounded.

## Functional Description

The SKY13373-460LF includes an internal negative voltage generator and decoder that eliminate the need for external DC blocking capacitors on the RF ports. No external components are required for proper operation. DC decoupling capacitors may be added on the VDD and control lines if necessary.

Switching is controlled by two control voltage inputs, V1 and V2. Depending on the logic voltage level applied to the control pins, the RFC (RF common) pin is connected to one of three switched RF outputs (J1, J2, or J3) through a low insertion path, while the path between the RFC pin and the other RF pins is in a high isolation state.

Shutdown mode is enabled by connecting all control pins to logic low. This mode reduces the overall current consumption of the device to 5  $\mu$ A, typical. To prevent the switch from accidentally entering shutdown mode during switching, all states must be set

to logic low for at least 20  $\mu$ s. When exiting shutdown mode, the switch as a 10.5  $\mu$ s startup time before switching occurs.

## Electrical and Mechanical Specifications

The absolute maximum ratings of the SKY13373-460LF are provided in Table 2. Electrical specifications are provided in Table 3.

The state of the SKY13373-460LF is determined by the logic provided in Table 4.

Typical performance characteristics of the SKY13373-460LF are illustrated in Figures 3 through 6.

**Table 2. SKY13373-460LF Absolute Maximum Ratings<sup>1</sup>**

Parameter	Symbol	Minimum	Maximum	Units
Supply voltage	V <sub>DD</sub>	2.5	4.8	V
Control voltage <sup>2</sup>	V <sub>CTL</sub>	1.65	3.30	V
Input power	P <sub>IN</sub>		+39	dBm
Storage temperature	T <sub>STG</sub>	-40	+125	°C
Operating temperature	T <sub>OP</sub>	-40	+85	°C

<sup>1</sup> Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

<sup>2</sup> Any bias voltage applied to the V1, V2, or V3 pins may damage the device if there is no bias voltage also present on the VDD pin. Maximum control voltage cannot exceed V<sub>DD</sub>.

**ESD HANDLING:** *Although this device is designed to be as robust as possible, electrostatic discharge (ESD) can damage this device. This device must be protected at all times from ESD when handling or transporting. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD handling precautions should be used at all times.*

**Table 3. SKY13373-460LF Electrical Specifications<sup>1</sup>**

(V<sub>DD</sub> = 2.3 V to 4.8 V, V<sub>1</sub> = V<sub>2</sub> = 0 to 1.8 V, T<sub>OP</sub> = +25 °C, P<sub>IN</sub> = 0 dBm, Characteristic Impedance [Z<sub>0</sub>] = 50 Ω, Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Typical	Max	Units
<b>RF Specifications</b>						
Insertion loss	IL	0.8 to 1.0 GHz		0.35	0.40	dB
		1.0 to 2.2 GHz		0.40	0.55	dB
		2.2 to 3.0 GHz		0.50	0.60	dB
		4.9 to 6.0 GHz		0.80	1.00	dB
Isolation	ISO	0.8 to 1.0 GHz	35	40		dB
		1.0 to 2.2 GHz	28	33		dB
		2.2 to 3.0 GHz	25	30		dB
		4.9 to 6.0 GHz	18	22		dB
Return loss	IS11I	0.8 to 6.0 GHz		17		dB
Third order input intercept point	IIP3	0.8 to 3.0 GHz, Δf = 1 MHz, P <sub>IN</sub> = +20 dBm/tone	+65	+70		dBm
Input 0.1 dB compression point	P0.1dB	0.8 to 6.0 GHz, RFC to J1, J2, and J3		+39		dBm
2 <sup>nd</sup> harmonic	2fo	0.8 to 3.0 GHz, P <sub>IN</sub> = +20 dBm		+85		dBc
3 <sup>rd</sup> harmonic	3fo	0.8 to 3.0 GHz, P <sub>IN</sub> = +20 dBm		+85		dBc
Switching rise time		10/90% RF		250		ns
Switching fall time		90/10% RF		250		ns
Switching on time		50% V <sub>CTL</sub> to 10/90% RF		1500		ns
Switching off time		50% V <sub>CTL</sub> to 90/10% RF		1500		ns
Startup time		Shutdown state to any RF switch state		20		μs
<b>DC Specifications</b>						
Control voltage:	V <sub>CTL_HIGH</sub> V <sub>CTL_LOW</sub>		1.65	1.80	3.00 (Note 2)	V
			0		0.4	V
Supply voltage	V <sub>DD</sub>		2.5		4.8	V
Supply current	I <sub>DD</sub>	V <sub>DD</sub> = 3.5 V		60		μA
Control current	I <sub>ctl</sub>	V <sub>1</sub> = V <sub>2</sub> = 1.8 V		2		μA
Shutdown mode supply current	I <sub>off</sub>	V <sub>DD</sub> = 3.5 V, V <sub>1</sub> = V <sub>2</sub> = 0 V		5		μA

<sup>1</sup> Performance is guaranteed only under the conditions listed in this table.

<sup>2</sup> Control voltage should not exceed supply voltage.

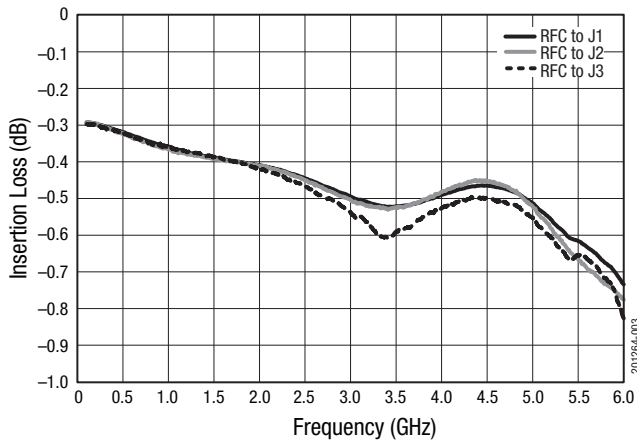
**Table 4. SKY13373-460LF Truth Table<sup>1</sup>**

V1 (Pin 4)	V2 (Pin 5)	State
0	0	Shutdown
1	0	RFC to J2
0	1	RFC to J1
1	1	RFC to J3

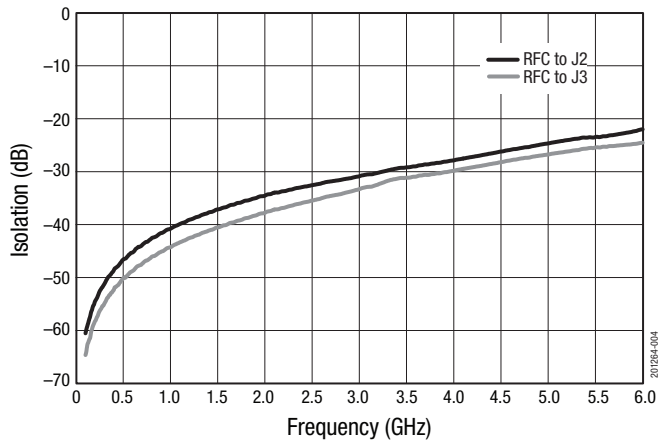
<sup>1</sup> 1 = 1.65 to 3.30 V; 0 = 0 to 0.4 V. Any state other than described in this table places the switch into an undefined state.

### Typical Performance Characteristics

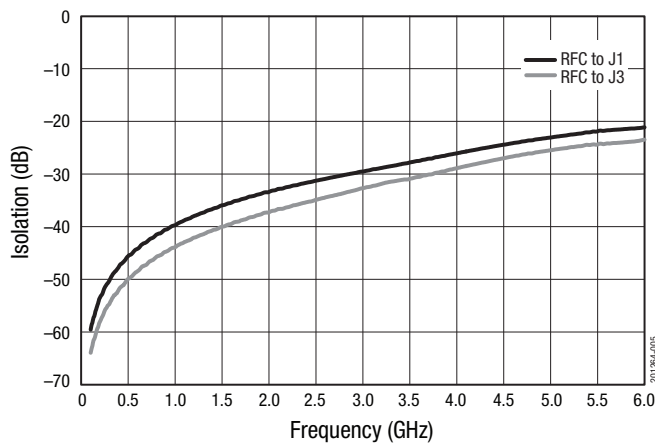
( $V_{DD} = 2.3\text{ V to }4.8\text{ V}$ ,  $V_1 = V_2 = 0\text{ to }1.8\text{ V}$ ,  $T_{OP} = +25\text{ }^\circ\text{C}$ ,  $P_{IN} = 0\text{ dBm}$ , Characteristic Impedance [ $Z_0$ ] =  $50\ \Omega$ , Unless Otherwise Noted)



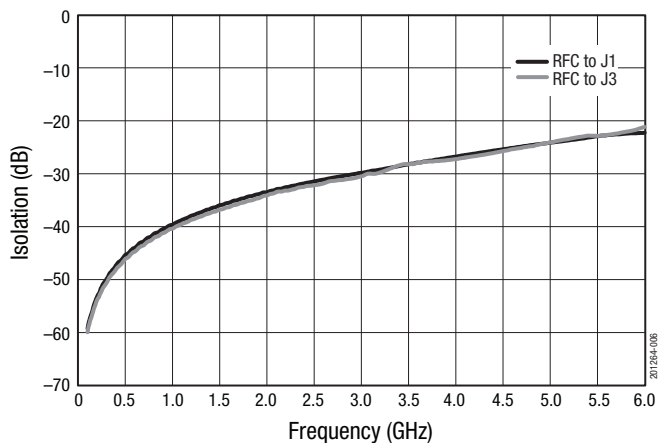
**Figure 3. Typical Insertion Loss vs Frequency**



**Figure 4. Typical Isolation vs Frequency (RFC to J1 Insertion Loss State)**



**Figure 5. Typical Isolation vs Frequency (RFC to J2 Insertion Loss State)**



**Figure 6. Typical Isolation vs Frequency (RFC to J3 Insertion Loss State)**

### Evaluation Board Description

The SKY13373-460LF Evaluation Board is used to test the performance of the SKY13373-460LF SP3T Switch. The board is made from a two-layer construction with ½ oz. copper cladding on top and bottom. The first layer material is 12-mil Rogers 4003C. The second layer material is 49-mil of FR4 for a total board thickness of about 62 mils. The impedance of all RF traces is 50 Ω.

An Evaluation Board schematic diagram is provided in Figure 7. An assembly drawing for the Evaluation Board is shown in Figure 8.

### Package Dimensions

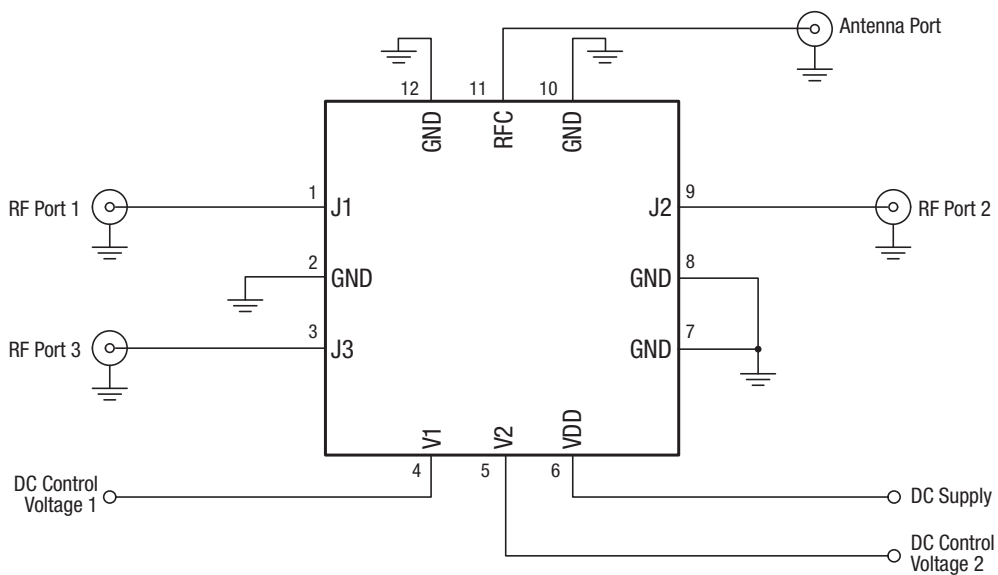
The PCB layout footprint for the SKY13373-460LF is provided in Figure 9. Typical part markings are shown in Figure 10. Package dimensions are shown in Figure 11, and tape and reel dimensions are provided in Figure 12.

### Package and Handling Information

Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

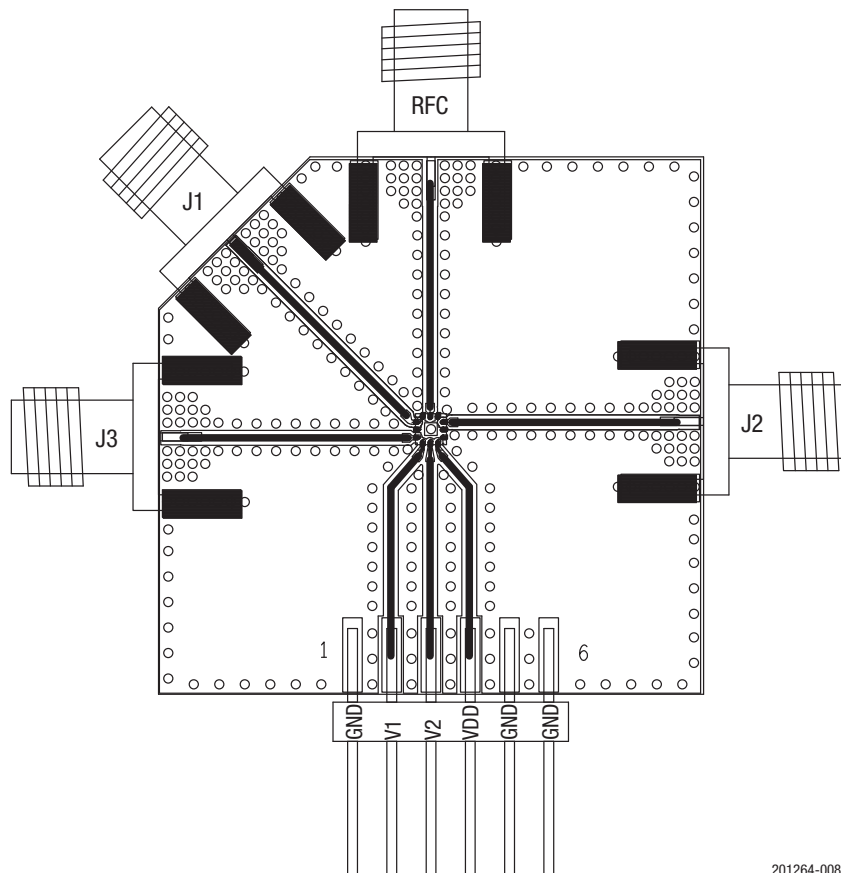
The SKY13373-460LF is rated to Moisture Sensitivity Level 1 (MSL1) at 260 °C. It can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note, *Solder Reflow Information*, document number 200164.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.



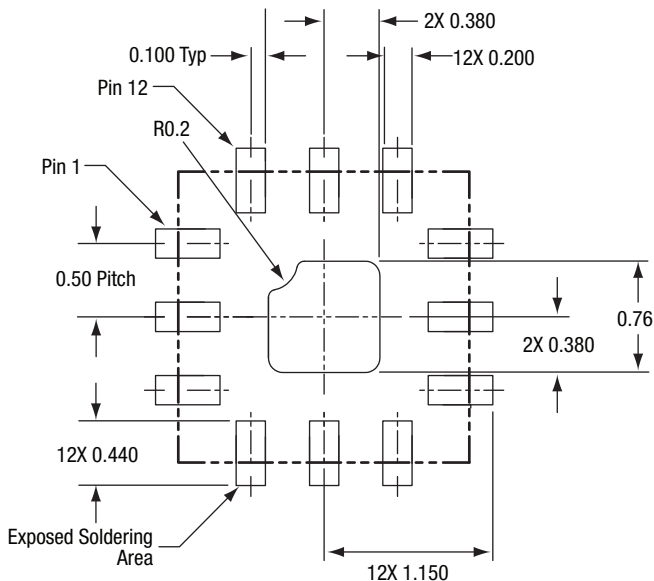
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**Figure 7. SKY13373-460LF Evaluation Board Schematic**



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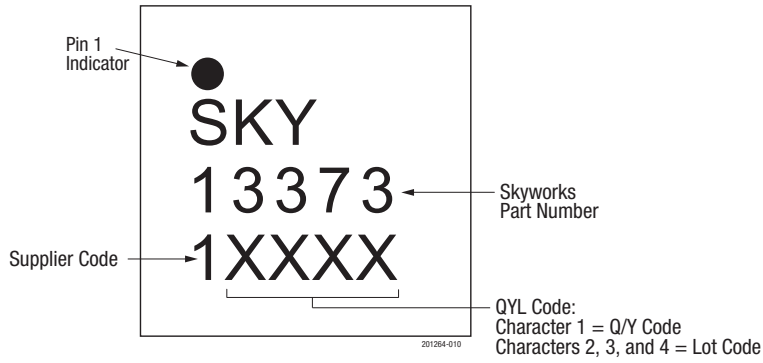
Figure 8. SKY13373-460LF Evaluation Board Assembly Diagram



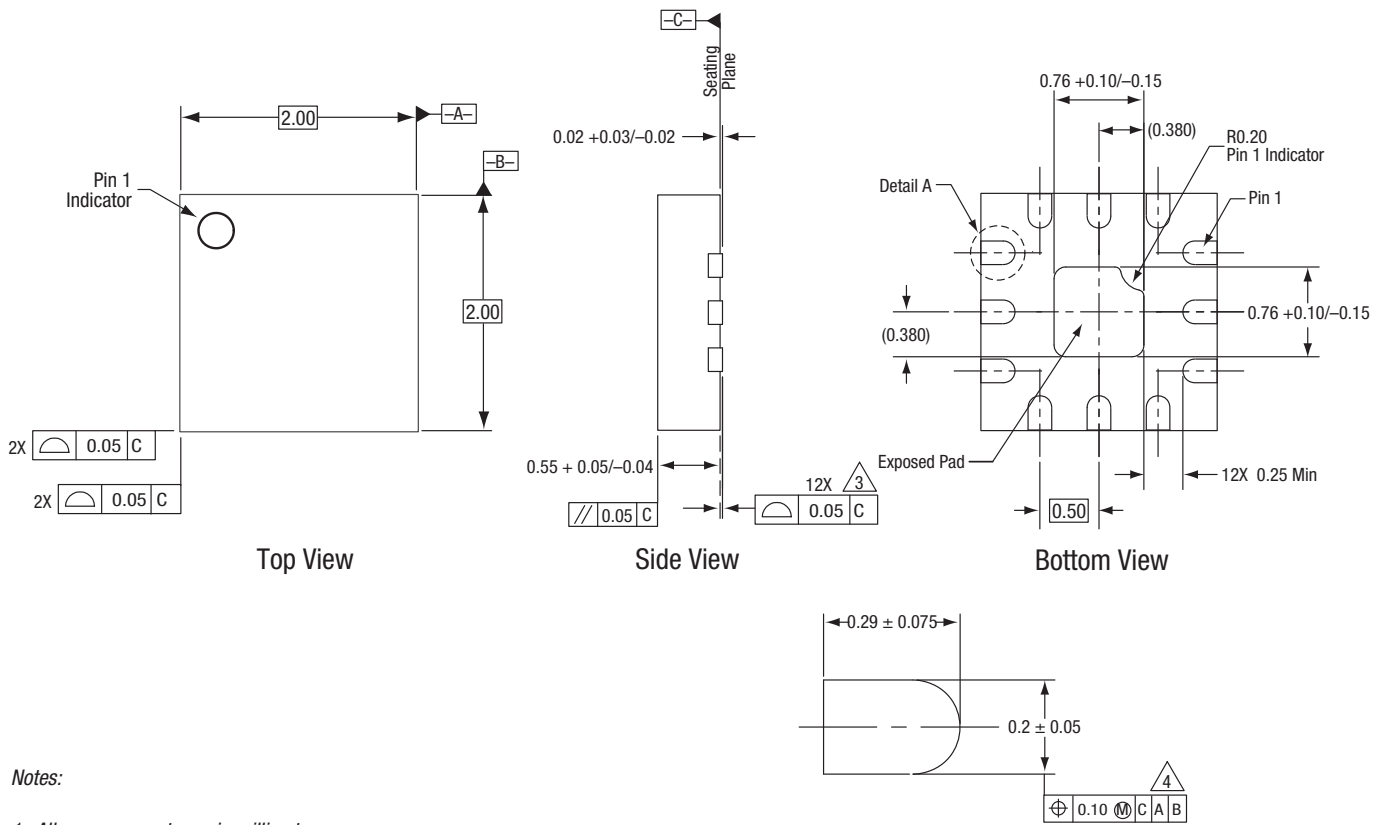
All measurements in millimeters

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Figure 9. SKY13373-460LF PCB Layout Footprint (Top View)



**Figure 10. Typical Part Markings (Top View)**



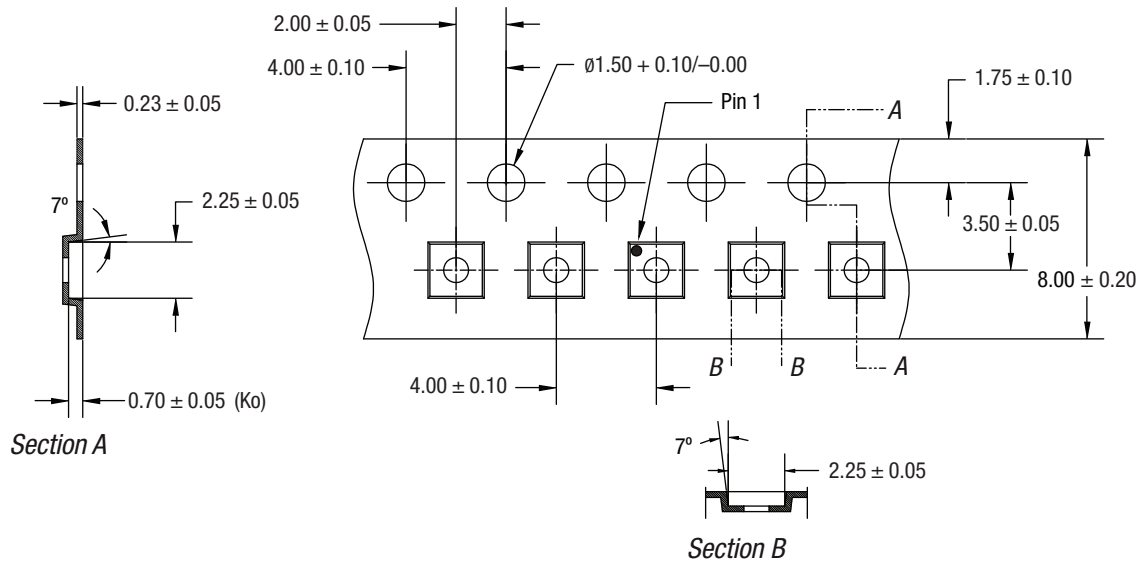
**Notes:**

1. All measurements are in millimeters.
2. Dimensions and tolerances according to ASME Y14.5M-1994.
3. Coplanarity applies to the terminals and all other bottom surface metallization.
4. Dimension applies to metallized terminal. If the terminal has a radius on its end, the width dimension should not be measured in that radius area.

**Detail A**  
Scale: 100X  
12 Places

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**Figure 11. SKY13373-460LF Package Dimensions**



Notes:

1. Carrier tape must meet all requirements of Skyworks GP01-D232 procurement spec for tape and reel shipping.
2. Carrier tape shall be black conductive polycarbonate bakeable material at 125 °C temperature.
3. Cover tape shall be transparent conductive with 5.40 mm width.
4. ESD-surface resistivity must meet all ESD requirements of Skyworks specified on GP01-D232.
5. All measurements are in millimeters.

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**Figure 12. SKY13373-460LF Tape and Reel Dimensions**